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**THERMALLY
CONDUCTIVE
PRE-PREG
DIELECTRIC.**



GENERAL INFORMATION

This **Thermally Conductive Pre-Preg** with its outstanding electrical insulating capability makes possible the use of metal base materials as heat spreaders in printed circuit board laminate.

This material's high thermal conductivity of approximately 3 W/mK, high dielectric strength of 800 V/mil, strong adhesion and room temperature stability make it ideal for use as a pre-preg in thermally conductive PCBs.

Customizations

